L Number	Hits	Search Text	DB	Time stamp
1	62	thermistor with substrate with paste	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:08
2	3	thermistor with embedded with paste	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:11
3	1304	against with (turning or rotating) with recess	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:12
4	15	against with (turning or rotating) with recess and probe	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:13
5	0	against with (turning or rotating) with recess and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:14
7	0	against with (turning or rotating) with indent and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:14
8	0	against with (turning or rotating) with indent and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:14
6	1	against with (turning or rotating) with beads and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:14
9	1	against with (turning or rotating) with locking and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:14
10	11	(turning or rotating) with locking and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:15
11	117	(turning or rotating or rotation) with against and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:17
12	125	(turning or rotating or rotation) with prevent and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:18

13	10	(turning or rotating or rotation) with prevent and sheath and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 19:18
-	1151	(374/185,148,183).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 16:35
-	691	(374/179).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 12:23
-	83	probe and (substrate or chip or circuit adj board) and sensor and o-ring and thread	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 16:39
-	218	probe and (substrate or chip or circuit adj board) and sensor and o-ring and thread	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 16:36
-	7	(probe and (substrate or chip or circuit adj board) and sensor and o-ring and thread) and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 16:37
-	0	probe and (substrate or chip or circuit adj board) and temeprature adj sensor and o-ring and thread	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 16:39
-	34	sheath and (substrate or chip or circuit adj board) and sensor and o-ring and thread and374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 17:42
-	25	sheath and (substrate or chip or circuit adj board) and temperature adj sensor and o-ring and thread	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 17:42
-	1	sheath and (substrate or chip or circuit adj board) and sensor and o-ring and thread and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 17:45
-	0	sheath and (substrate or chip or circuit adj board) and sensor and gasket and thread and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 17:45
-	0	sheath and (substrate or chip or circuit adj board) and sensor and gasket and thread and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 17:45

-	5	sheath and (substrate or chip or circuit adj board) and sensor and o-ring and threaded and 374/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 17:46
-	324	374/144.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 17:52
-	139	374/149.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 17:52
-	42	probe and (substrate or chip or circuit adj board) and temperature adj sensor and o-ring and thread	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 17:55
-	4	"0794417"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:42
-	8	"0364579"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:44
-	0	0364579A1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:44
-	0	"0364579" adj A1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:44
-	334	delphi and @pd<19970901 and @pd<19970930	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:45
-	0	delphi.as and @pd<19970901 and @pd<19970930	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:45
-	252	delphi.as. and @pd<19970901 and @pd<19970930	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:45
-	16	delphi.as. and @pd<19970901 and @pd<19970930 and temperature	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:47
-	1	1995-384350.NRAN.	DERWENT	2002/09/16 18:47
-	1	1997-228505.NRAN.	DERWENT	2002/09/16 18:47

-	0	delphi.as. and @pd<19970901 and @pd<19970930 and "794417"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:48
-	0	delphi.as. and @pd<19970901 and @pd<19970930 and "0794417"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:48
-	7	delphi.as. and @pd<19970901 and @pd<19970930 and resistor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:49
-	1	1996-222064.NRAN.	DERWENT	2002/09/16 18:48
-	0	"000364579"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:49
-	8	"0364579"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:49
-	0	delphi.as. and @pd<19970901 and @pd<19970930 and probe	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/09/16 18:49